Docket No. 237457US90CONT/hc

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

GAU:

IN RE APPLICATION OF: Yasuji HIRAMATSU, et al.

SERIAL NO: 10/615,950

FILED: July 10, 2003 EXAMINER:

FOR: CERAMIC SUBSTRATE FOR SEMICONDUCTOR FABRICATING DEVICE

# INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

#### REFERENCES

- The applicant(s) wish to make of record the references, some of which are cited in the attached International Search Report listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

#### RELATED CASES

- Attached is a list of applicant's pending application(s) or issued patent(s) which may be related to the present application. A copy of the patent(s), together with a copy of the claims and drawings of the pending application(s) is attached along with PTO 1449.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

#### CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- □ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

### DEPOSIT ACCOUNT

Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number <u>15-0030</u>. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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SHEET

SHEET 1 OF 1

			ATTY DOCKET NO.		SERIAL NO.			
Form PTO 1449 U.S. DEPARTMENT OF COMMERCE (Modified) PATENT AND TRADEMARK OFFICE			ATTY DOCKET NO. 237457US90CONT 10/615,950					
				APPLICANT				
LIST OF I	REFER	ENCES CITED BY AP	PLICANT	Yasuji HIRAMATSU, et al.				
LIST OF REPERLINGES SINES STATE ELECTRICAL				FILING DATE		GROUP		
				July 10, 2003				
				U.S. PATENT DOCUMENTS				
		DOCUMENT	T	NAME	SUB FILING DATE			
EXAMINER INITIAL		NUMBER	DATE	NAME Y. HIRAMATSU, et al.	CLASS	CLASS	IF APP	ROPRIATE
	AA	6,507,006	01/14/2003			† †		
	_AB	6,465,763	10/15/2000	Y. ITO, et al.				
	AC	6,475,606	11/05/2000	T. NIWA		<del>                                     </del>		
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			F	OREIGN PATENT DOCUMENTS				
	Т	DOCUMENT	DOCUMENT DATE COUNTRY			TRANSLATION		
		NUMBER DATE COUNTRY			YES		NO	
	AO	11-251040	09/17/99	JAPAN (with English Abstract)				X
	AP	9-270454	10/14/97	JAPAN (with English Abstract)				X
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	AV							
		OTHER	REFERENCES	6 (Including Author, Title, Date, Pertine	ent Pages,	, etc.)		
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	AZ				A	dditional Re	eferences s	sheet(s) attach
Evaminer					Date	Date Considered		
Examiner								

## LIST OF RELATED CASES

Docket Number PER CLIENT	Serial or Patent Number 09/471,759	Filing or <u>Issue Date</u> 12/23/99	Inventor/ Applicant SAITO et al.
PER CLIENT	09/462,067	01/05/01	FURUKAWA et al.
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<sup>\*</sup>Present Application; listed for information GJM/sb/akh
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<sup>\*</sup>Present Application; listed for information GJM/sb/akh
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